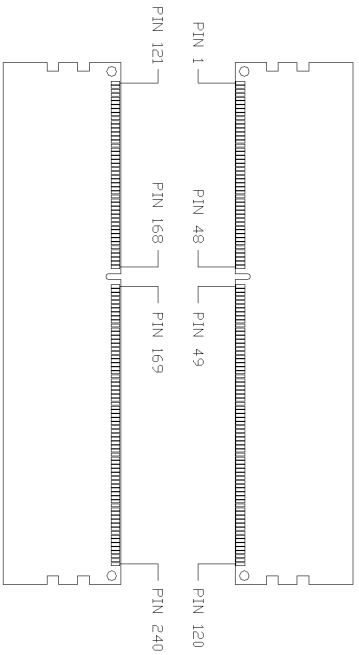
GR 1333 D3 64 L9 4G

GOODRAM
SPEED / DATA TRANSFER 1333MHz / PC3-10600
MODULE TYPE DDR3 SDRAM DIMM
MODULE DATA WIDTH 64
CAS LATENCY 9
MODULE DENSITY 4GB

DDR III MODULE PART NUMBERING SYSTEM

GOOD RAM
professional memory for everyone

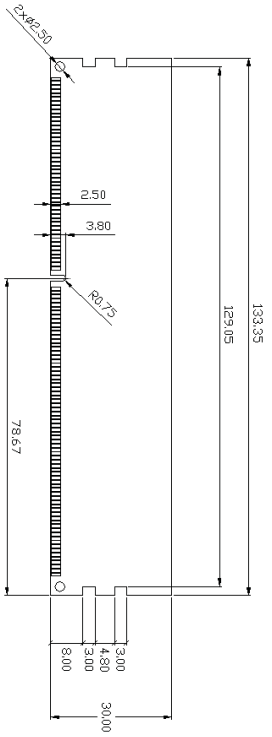


FEATURES

PART NUMBER	GR1333D364L9/4G
MODULE TYPE	DDR3 SDRAM DIMM
MODULE DENSITY	4GB
MODULE DATA WIDTH	64
DRAM COMPONENT ORAGNIZATION	256Mx8
NUMBER OF DRAM COMPONENTS	16
NUMBER OF MODULE RANKS	2
NUMBER OF MODULE SIDES	2
REGISTERED	NO
ECC SUPPORT	NO
PIN COUNT	240 PIN
SUPPLY VOLTAGE	1,50V
SSTL_15 COMPATIBLE	YES

DYNAMIC PARAMETERS FOR 1333MHz

CAS LATENCY	9
RAS# TO CAS# DELAY, tRCD	9
ROW PRECHARGE TIME, tRP	9
ACTIVE TO PRECHARGE TIME, tRAS	24



PCB DETAILS

PCB TYPE	DDR3 SDRAM DIMM
BOARD DIMENSIONS	133,35 x 30mm ± 0,1mm
BOARD THICKNESS	1,27mm ± 0,1mm
DRAM PACKAGE INFORMATION	FBGA, x8bit
CONTACT PADS (PIN)	GOLD PLATED

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SPD CONFIGURATION

BYTE	DESCRIPTION	HEX	DEC
0	Number of Serial PD Bytes Written / SPD Device Size / CRC Coverage	0x92	146
1	SPD Revision	0x10	16
2	Key Byte / DRAM Device Type	0x0B	11
3	Key Byte / Module Type	0x02	2
4	SDRAM Density and Banks	0x03	3
5	SDRAM Addressing	0x19	25
6	Reserved	0x00	0
7	Module Organization	0x09	9
8	Module Memory Bus Width	0x03	3
9	Fine Timebase Dividend and Divisor	0x52	82
10	Medium Timebase Dividend	0x01	1
11	Medium Timebase Divisor	0x08	8
12	SDRAM Maximum Cycle Time (tCKmax)	0x0C	12
13	Reserved	0x00	0
14	CAS Latencies Supported, Least Significant Byte	0x3C	60
15	CAS Latencies Supported, Most Significant Byte	0x00	0
16	Minimum CAS Latency Time(tAAmin)	0x69	105
17	Minimum Write Recovery Time (tWRmin)	0x78	120
18	Minimum RAS# to CAS# Delay Time (tRCDmin)	0x69	105
19	Minimum Row Active to Row Active Delay Time (tRRDmin)	0x30	48
20	Minimum Row Precharge Time (tRPmin)	0x69	105
21	Upper Nibbles for tRAS and tRC	0x11	17
22	Minimum Active to Precharge Time (tRASmin), Least Significant Byte	0x20	32
23	Minimum Active to Active/Refresh Time (tRCmin), Least Significatn	0x89	137
24	Minimum Refresh Recovery Time (tRFCmin), Least Significant Byte	0x00	0
25	Minimum Refresh Recovery Time (tRFCmin), Most Significant Byte	0x05	5
26	Minimum Internal Write to Read Command Delay Time (tWTRmin)	0x3C	60
27	Minimum Internal Read to Precharge Command Delay Time (tRTPmin)	0x3C	60
28	Upper Nibble for tFAW	0x00	0
29	Minimum Four Activate WIndow Delay Time (tFAWmin), Least Significa	0xF0	240
30	SDRAM Output Drivers supported	0x82	130
31	SDRAM Thermal and Refresh Options	0x01	1
32-59	Reserved, General Section	0x00	0
60	Module Nominal Height	0x0F	15
61	Module Maximum Thickness	0x11	17
62	Reference Raw Card Used	0x01	1
63	Address Mapping from Edge Connector to DRAM	0x01	1
64-116	Reserved	0x00	0
117	Module Manufacturer ID Code, Least Significant Byte	0x00	0
118	Module Manufacturer ID Code, Most Significant Byte	0x00	0
119	Module ID: Module Manufacturing Location	0x00	0
120	Module ID: Module Manufacturing Date	0x00	0
121	Module ID: Module Manufacturing Date	0x00	0
122	Module ID : Module Serial Number	0x00	0
123	Module ID : Module Serial Number	0x00	0
124	Module ID : Module Serial Number	0x00	0
125	Module ID : Module Serial Number	0x00	0
126	Cyclic Redundancy Code	0x4E	78
127	Cyclic Redundancy Code	0x3D	61

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